

LVDS Interface ICs

27bit LVDS Transmitter BU90T81



General Description

The BU90T81 transmitter operates from 20MHz to 112MHz wide clock range, and 27bits data of parallel LVCMOS level inputs(R/G/B24bits and VSYNC,HSYNC,DE) are converted to four channels of LVDS data stream. Data is transmitted seven times (7X) stream and reduce cable number by 3(1/3) or less.

The BU90T81 operates from a single 1.8V supply for low power. And the BU90T81 has low swing mode to be able to expect further low power and low EMI.

Features

- ■24bits data of parallel LVCMOS level inputs are converted to four channels of LVDS data stream.
- ■Support clock frequency from 20MHz up to 112MHz.
- ■Low power 1.8V CMOS design
- ■Power down mode
- ■Clock edge selectable
- ■Support 6bit/8bit mode selectable
- ■Support reduced swing LVDS for low EMI.
- ■Support LVDS Outputs pin reverse function
- ■Support spread spectrum clock generator input

Key Specifications

- ■Supply Voltage range 1.65 to 1.95 V
 ■Operating frequency 20 to 112MHz
 ■Operating Temperature Range −20 to 85°C
- ■Power Consumption 50mW(Typ)

Packages

VBGA048W040

 $4.00 \text{ mm} \times 4.00 \text{ mm} \times 0.90 \text{ mm}$

Applications

- ■Tablet
- ■Netbook PC
- ■Digital Picture Frame

Block Diagram

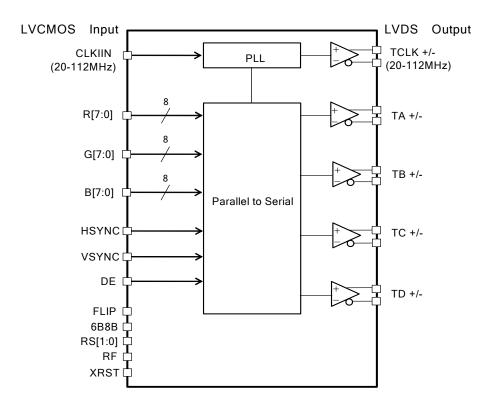
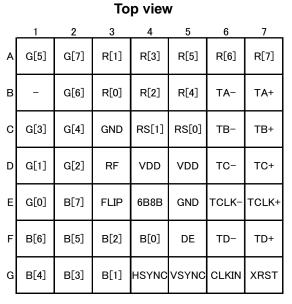


Figure-1 Block Diagram

OProduct structure: Silicon monolithic integrated circuit oThis product is not designed protection against radioactive rays

●Pin Configuration



48pin VBGA

Figure-2 Pin Diagram (Top View)

● Pin Description

Pin Name	Pin No.	Туре	Descriptions	
TA+/-, TB+/-, TC+/-,TD+/-	B7,B6,C7,C6,D7,D6,F7,F6	LVDS	LVDS Data out	
TCLK+/-	E7,6	OUT	LVDS Clock out	
R[7:0]	A7,A6,A5,B5,A4,B4,A3,B3			
G[7:0]	A2,B2,A1,C2,C1,D2,D1,E1		Pixel and control data inputs	
B[7:0]	E2,F1,F2,G1,G2,F3,G3,F4	CMOS	The and control data inputs	
HSYNC,VSYNC, DE	G4,G5,F5	IN		
CLKIN	G6		Clock input	
XRST	G7		Power Down H:Normal operation L:Power down (all LVDS output signal are Hi-z)	
RF	D3	CMOS IN	Input CLK Triggering Edge Select. H: Rising edge L: Falling edge	
RS[1:0]	C3,C5			LVDS swing mode select RS1 RS0 LVDS swing L L TYP=160mV L H TYP=200mV H L TYP=350mV H H Reserved
6B8B	E4		6bit/8bit mode select H: 6bit mode(FLIP=L TD+/- is Hiz) (FLIP=H TA+/- is Hiz) L: 8bit mode	
FLIP	E3		LVDS output pin reverse select. H: Reverse L: Normal	
VDD	D4,D5	POWER	1.8V Power supply	
GND	C3,E5	GND	Ground Pins	

● Absolute Maximum Ratings

Dorometer	Symbol	Rat	Heita	
Parameter	Symbol	Min	Max	Units
Supply Voltage	V_{DD}	-0.3	2.5	V
Input Voltage	V _{IN}	-0.3	V _{DD} +0.3	V
Output Voltage	V _{OUT}	-0.3	V _{DD} +0.3	V
Storage Temperature Range	Tstg	-55	125	°C

Operating Ratings

gg						
	Symbol		Rating		- Units	Conditions
Parameter	Symbol	Min	Тур	Max		
Supply Voltage	V_{DD}	1.65	1.8	1.95	V	
Operating Temperature Range	Topr	-20	-	85	°C	
Operating frequency	Fmax	20	-	112	MHz	

● Package Power

Package	Power Dissipation (mW)	De-rating (mW/°C)*1
VBGA048W040	800*1	8.0*1

^{*1:}Package power when mounting on the PCB board.

The size of PCB board : 114.3×76.2×1.6(mm³)
The material of PCB board : The FR4 glass epoxy board.

DC characteristics

Table 1 : LVCMOS DC Specifications (V_{DD}=1.65V \sim 1.95V, Ta=-20°C \sim +85°C)

Symbol	Parameter	Parameter Rating		Units	Conditions	
Symbol	Farameter	Min	Тур	Max	Ullits	Conditions
V _{IH}	High Level Input Voltage	V _{DD} ×0.7	-	V_{DD}	V	
V _{IL}	Low Level Input Voltage	GND	-	V _{DD} ×0.3	V	
I _{INC}	Input Current	-10	-	+10	μA	0V≤V _{IN} ≤V _{DD}

Table2: LVDS Transmitter DC Specifications (V_{DD}=1.65V~1.95V, Ta=-20°C~+85°C)

Symbol	Symbol Parameter -		Rating		Units	Conditions	
Symbol	Parameter	Min	Тур	Max	Units	Conditions	
	V _{OD} Differential Output Voltage	250	350	450	mV		RS[1:0]= HL
V_{OD}		130	200	270	mV	RL=100Ω	RS[1:0]= LH
		110	160	210	mV		RS[1:0]= LL
ΔV_{OD}	Change in VOD between complementary output states	-	-	35	mV		
Voc	Common Mode Voltage	1.125	1.25	1.375	V	RL=100Ω	
ΔV _{oc}	Change in VOC between complementary output states	-	-	35	mV		
Ios	Output Short Circuit Current	-90			mA	V _{OUT} =0V	
loz	Output TRI-STATE Current	-10	-	+10	μA	XRST=0V, V _{OUT} =0V to V	DD

AC characteristics

Table 3 : Switching Characteristics (VDD=1.8V, Ta=25°C RL=100 Ω CL=5pF RS[1:0]=HL)

Symbol	Param		Min	Тур	Max	Units
t _{TCP}	CLK OUT	8.93	-	50	ns	
t _{TCIT}	CLK IN Transition time		-	-	5.0	ns
t _{TCH}	CLK IN Hi	gh Time	0.35t _{TCP}	0.5t _{TCP}	0.65t _{TCP}	ns
t _{TCL}	CLK IN Lo	ow Time	0.35t _{TCP}	0.5t _{TCP}	0.65t _{TCP}	ns
t _{TS}	LVSMOS Data S	et up to CLK IN	2.5	-	-	ns
t _{TH}	LVCMOS Data Ho	old from CLK IN	0	•	-	ns
t _{LVT}	LVDS Trans	sition Time	-	0.6	1.5	ns
T_{TSUP}	Differential Output Set up Time	CLKOUT=112MHz	-	-	200	ps
T_{THLD}	Differential Output Hold time	CLKOUT=112MHz	-	-	200	ps
t _{TOP6}	Output Data	Position 6	$2\frac{\text{tTCP}}{7} - \text{T}_{\text{THLD}}$	2 ttcp 7	$2\frac{\text{tTCP}}{7} + \text{T}_{\text{TSUP}}$	ns
t _{TOP5}	Output Data	Position 5	$3\frac{\text{tTCP}}{7} - T_{\text{THLD}}$	3 ttcp 7	$3\frac{\text{tTCP}}{7} + T_{\text{TSUP}}$	ns
t _{TOP4}	Output Data	Position 4	$4\frac{\text{tTCP}}{7} - \text{T}_{\text{THLD}}$	4 ttcp 7	$4\frac{\text{tTCP}}{7} + \text{T}_{\text{TSUP}}$	ns
t _{TOP3}	Output Data	Position 3	$5\frac{\text{tTCP}}{7} - T_{\text{THLD}}$	5 ttcp 7	$5\frac{\text{tTCP}}{7} + \text{T}_{\text{TSUP}}$	ns
t _{TOP2}	Output Data Position 2		$6\frac{\text{tTCP}}{7} - \text{T}_{\text{THLD}}$	6 ttcp 7	$6\frac{\text{tTCP}}{7} + \text{T}_{\text{TSUP}}$	ns
t _{TOP1}	Output Data Position 1		$7\frac{\text{tTCP}}{7} - T_{\text{THLD}}$	7 ttcp 7	$7\frac{\text{tTCP}}{7} + \text{T}_{\text{TSUP}}$	ns
t _{TOP0}	Output Data	Position 0	$8\frac{\text{tTCP}}{7}$ - T _{THLD}	8 ttcp 7	$8\frac{\text{tTCP}}{7} + \text{T}_{\text{TSUP}}$	ns
t _{TPLL}	Phase Locked I	oop Set Time	-	-	10	ms

●AC Timing Diagrams

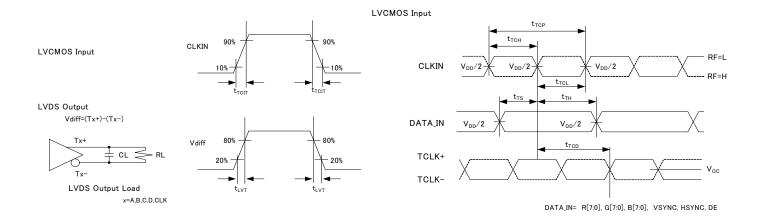


Figure-3 LVCMOS Input AC Timing Diagrams

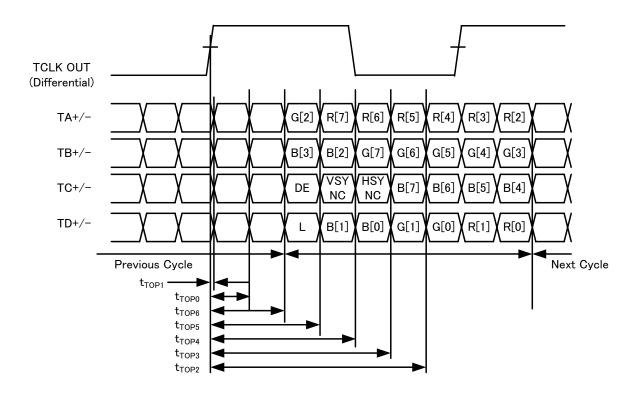


Figure-4 LVDS Output AC Timing Diagrams

● Phase Locked Loop Set Time

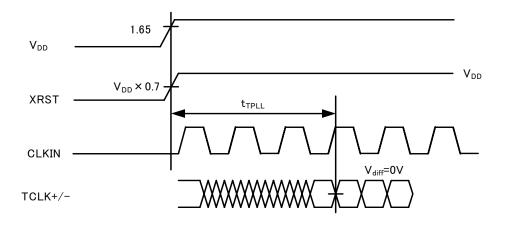


Figure-5 Phase Locked Loop Set Time

Supply Current

Table 4: Supply Current (6B8B = L)

	Parameter	Parameter Rating		Units	Conditions		
Symbol	Parameter	Min	Тур	Max	Ullits	Conditions	
		-	30.4	,	mA	RL=100Ω,CL=5pF VDD=1.8V,RS[1:0]=HL Gray Scale Pattern f=85MHz	
I _{TCCG}	I _{TCCG} Transmitter Supply Current	-	22.5	,	mA	RL=100Ω,CL=5pF VDD=1.8V,RS[1:0]=LH Gray Scale Pattern f=85MH:	
		-	20.4	'	mA	RL=100Ω,CL=5pF VDD=1.8V, RS[1:0]=LL Gray Scale Pattern f=85MHz	
		-	32.4	,	mA	RL=100Ω,CL=5pF VDD=1.8V, RS[1:0]=HL Worst case Pattern f=85MHz	
I _{TCCW}	Transmitter Supply Current	-	24.5	-	mA	RL=100Ω,CL=5pF VDD=1.8V, RS[1:0]=LH Worst case Pattern f=85MH:	
		-	22.4	-	mA	RL=100Ω,CL=5pF VDD=1.8V, RS[1:0]=LL Worst case Pattern f=85MHz	
I _{TCCS}	Transmitter Power Down Supply Current	-	-	10	μΑ	XRST=L	

Gray Scale Pattern

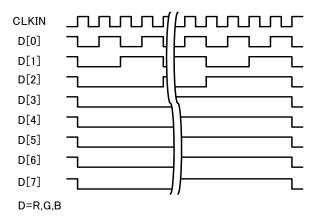


Figure -6 Gray Scale Pattern

Worst Case Pattern (Maximum Power condition)

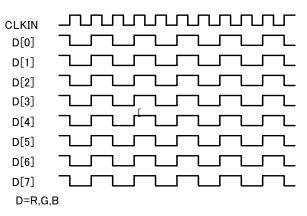
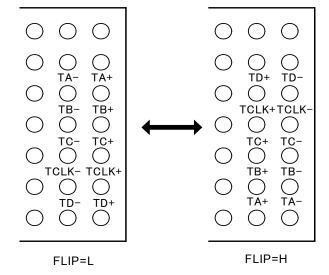


Figure -7 Worst Case Pattern

●LVDS Data Output Table for Function of FLIP pin

Table 5: LVDS Data Output Pin Name

	Output Pi	n Names
Pin No	FLIP=L	FLIP=H
B7	TA+	TD-
B6	TA-	TD+
C7	TB+	TCLK-
C6	TB-	TCLK+
D7	TC+	TC-
D6	TC-	TC+
E7	TCLK+	TB-
E6	TCLK-	TB+
F7	TD+	TA-
F6	TD-	TA+



●LVCMOS Data Inputs Pixel Map Table

Table 6: LVCMOS Data Inputs Pixel Map Table

	TFT Panel Da	BU90T81 Input	
	24Bit	18Bit	BO90101 Iliput
LSB	R0	-	R0
	R1	-	R0
	R2	R0	R1
	R3	R1	R2
	R4	R2	R3
	R5	R3	R4
	R6	R4	R5
MSB	R7	R5	R6
LSB	G0	-	R7
	G1	-	G0
	G2	G0	G1
	G3	G1	G2
	G4	G2	G3
	G5	G3	G4
	G6	G4	G5
MSB	G7	G5	G6
LSB	В0	-	G7
	B1	-	В0
	B2	B0	B1
	В3	B1	B2
	B4	B2	B3
	B5	В3	B4
	B6	B4	B5
MSB	B7	B5	B6
	VSYNC	VSYNC	B7
	HSYNC	HSYNC	HSYNC
	DE	DE	DE

●LVDS Output Data Mapping

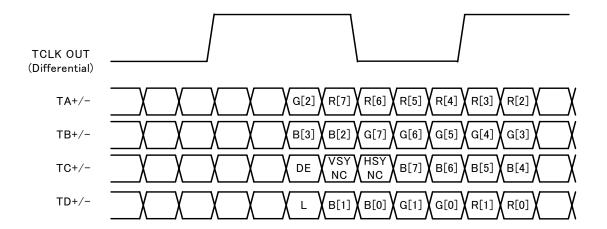


Figure-8 LVDS output mapping (6B8B=L, FLIP=L)

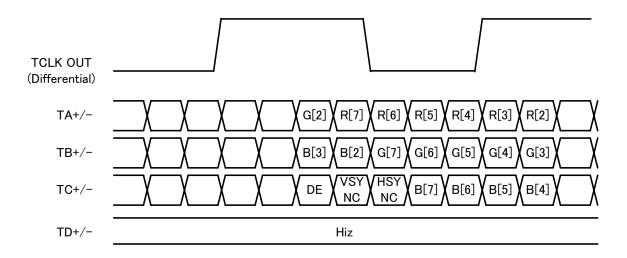


Figure-9 LVDS output mapping (6B8B=H, FLIP=L)

● Typical Application Circuit (24bit mode)

Example

BU90T81: LVCMOS Data Input /rising edge/200mV swing output/normal output mapping

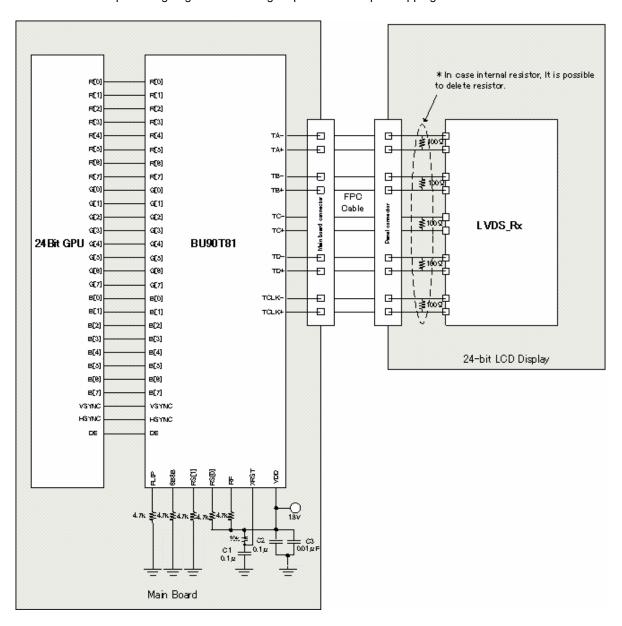


Figure-10 Application Circuit (24bit mode)

Datasheet

● Typical Application Circuit (18bit mode)

Example

BU90T81: LVCMOS Data Input /rising edge/200mV swing output/normal output mapping

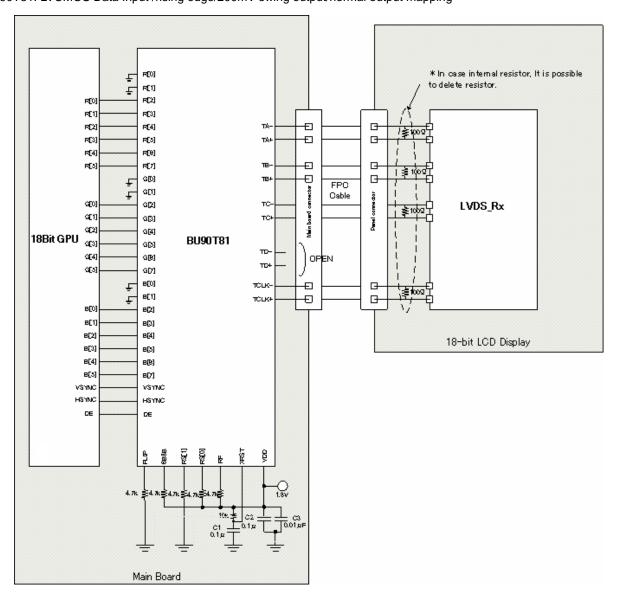


Figure-11 Application Circuit (18bit mode)

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If there are any differences in translation version of this document formal version takes priority

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Rev.001



BU90T81 - Web Page

Distribution Inventory

Part Number	BU90T81
Package	VBGA048W040
Unit Quantity	2500
Minimum Package Quantity	2500
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes